

LINEAR TECHNOLOGY MATERIALS DECLARATION

ltc1450lin#pbf

(Engineering Calculation)

PDIP

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TOTAL MASS (g) : 1.585085

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.005144	1000000	3245.25170898		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.458357	975000	289168.71875		
		Iron (Fe)	7439-89-6	0.011283	24000	7118.22998047		
		Phosphorus (P)	7723-14-0	0.000141	300	88.9542160034		
		Zinc (Zn)	7440-66-6	0.000329	700	207.559844971		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.470110	1000000	296583.4375		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.037246	1000000	23497.8027344		
		External Plating Total:				0.037246	1000000	23497.8027344
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.003761	1000000	2372.7434082		
Internal Plating Total:				0.003761	1000000	2372.7434082		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001325	750000	835.917236328		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000442	250000	278.849395752		
Die Attach Total:				0.001767	1000000	1114.76672363		
Encapsulation	FILLED EPOXY RESIN	Resin (EP)		0.143937	135000	90807.1171875		
		Bromine (Br)	40039-93-8	0.007463	7000	4708.26464844		
		Silica (SiO2)	60676-86-0	0.895608	840000	565022.0625		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.013861	13000	8744.64160156		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.005331	5000	3363.22631836		
		Encapsulation Total:				1.066200	1000000	672645.3125
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000857	1000000	540.664978027		
					TOTAL MASS (g) :	1.585085		